



PESD4V0Z1BCSF

Extremely low capacitance bidirectional ESD protection diode

29 March 2019

Product data sheet

1. General description

Extremely low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode, part of the TrEOS protection family. The device is housed in a DSN0603-2 (SOD962-2) leadless ultra small Surface-Mounted Device (SMD) package designed to protect one signal line from the damage caused by ESD and other transients.

2. Features and benefits

- Bidirectional ESD protection of one line
- Extremely low diode capacitance $C_d = 0.45$ pF
- Extremely low clamping to protect sensitive I/Os
- Extremely low inductance protection path to ground
- ESD protection up to ± 30 kV according to IEC 61000-4-2
- Surge robustness $I_{PPM} = 15$ A according to IEC 61000-4-5
- Ultra small SMD package

3. Applications

- Cellular handsets and accessories
- Portable electronics
- Communication systems
- Computers and peripherals

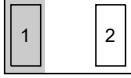
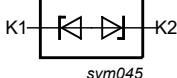
4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{RWM}	reverse standoff voltage		-	-	4	V
C_d	diode capacitance	$f = 1$ MHz; $V_R = 0$ V; $T_{amb} = 25$ °C	-	0.45	0.6	pF

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K1	cathode (diode 1)	 <p>Transparent top view</p> <p>DSN0603-2 (SOD962-2)</p>	 <p>sym045</p>
2	K2	cathode (diode 2)		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PESD4V0Z1BCSF	DSN0603-2	silicon, leadless ultra small package; 2 terminals; 0.4 mm pitch; 0.6 mm x 0.3 mm x 0.3 mm body	SOD962-2

7. Marking

Table 4. Marking codes

Type number	Marking code
PESD4V0Z1BCSF	C4

8. Limiting values

Table 5. Limiting values

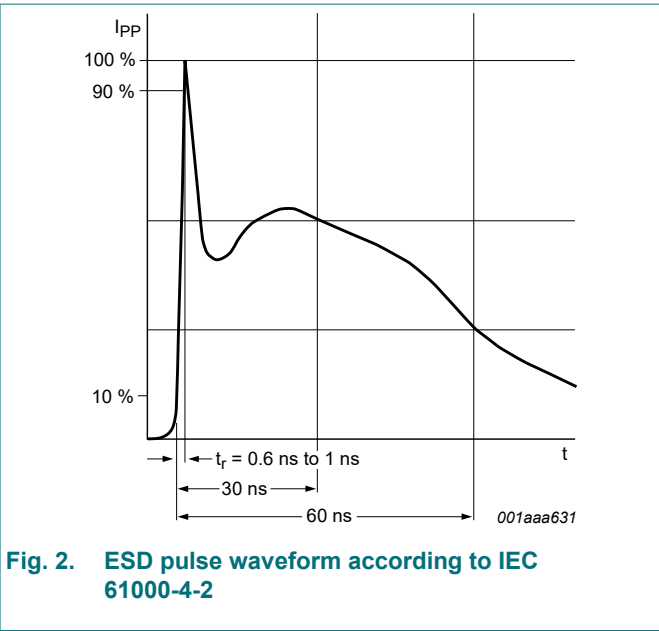
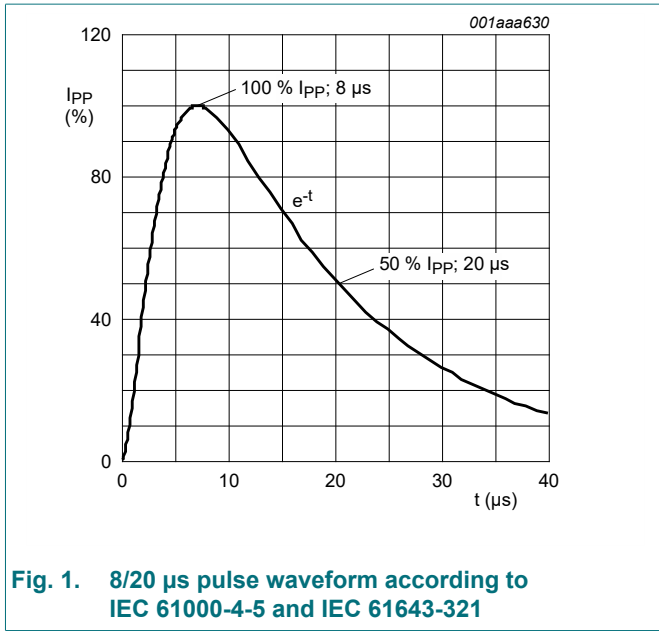
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{RWM}	reverse standoff voltage			-	4	V
I_{PPM}	rated peak pulse current	$t_p = 8/20 \mu s$	[1] [2]	-	15	A
T_{amb}	ambient temperature			-40	125	°C
T_{stg}	storage temperature			-65	150	°C
ESD maximum ratings						
V_{ESD}	electrostatic discharge voltage	IEC 61000-4-2; contact discharge	[3]	-30	30	kV
		IEC 61000-4-2; air discharge	[3]	-30	30	kV

[1] Device stressed with 8/20 μs exponential decay waveform according to IEC 61000-4-5.

[2] In positive and negative direction.

[3] Device stressed with ten non-repetitive ESD pulses.



9. Characteristics

Table 6. Characteristics

t_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{BR}	breakdown voltage	I _R = 1 mA	-	6.8	-	V
I _{RM}	reverse leakage current	V _{RWM} = 4 V; T _{amb} = 25 °C	[1]	1	50	nA
C _d	diode capacitance	f = 1 MHz; V _R = 0 V; T _{amb} = 25 °C	-	0.45	0.6	pF
		f = 1 MHz; V _R = 1.5 V	-	0.4	-	pF
V _{CL}	clamping voltage	I _{PPM} = 4 A	[2]	3.1	-	V
		I _{PPM} = 15 A	[2]	4.8	-	V
R _{dyn}	dynamic resistance	I _R = 10 A	[3]	0.11	-	Ω
		I _R = -10 A	[3]	0.11	-	Ω
f _{-3dB}	-3 dB cut-off frequency	normalized to attenuation at 1 MHz	-	14.3	-	GHz

[1] Guaranteed by design.

[2] Device stressed with 8/20 μs exponential decay waveform according to IEC 61000-4-5.

[3] Non-repetitive current pulse, Transmission Line Pulse (TLP); square pulse; ANSI / ESD STM5.5.1-2008.

Extremely low capacitance bidirectional ESD protection diode

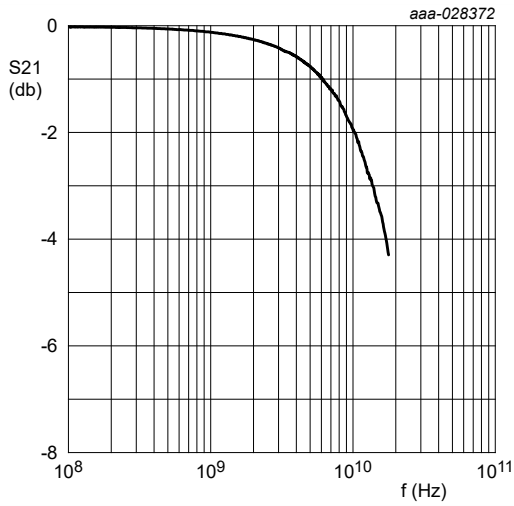
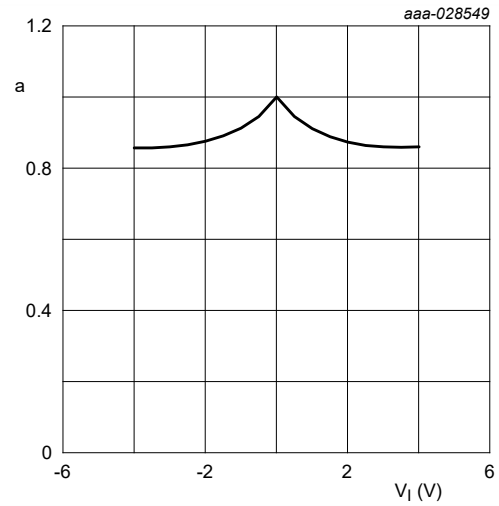
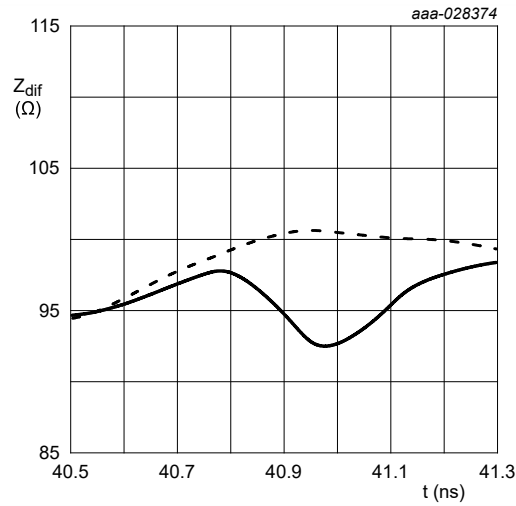


Fig. 3. Insertion loss; typical values



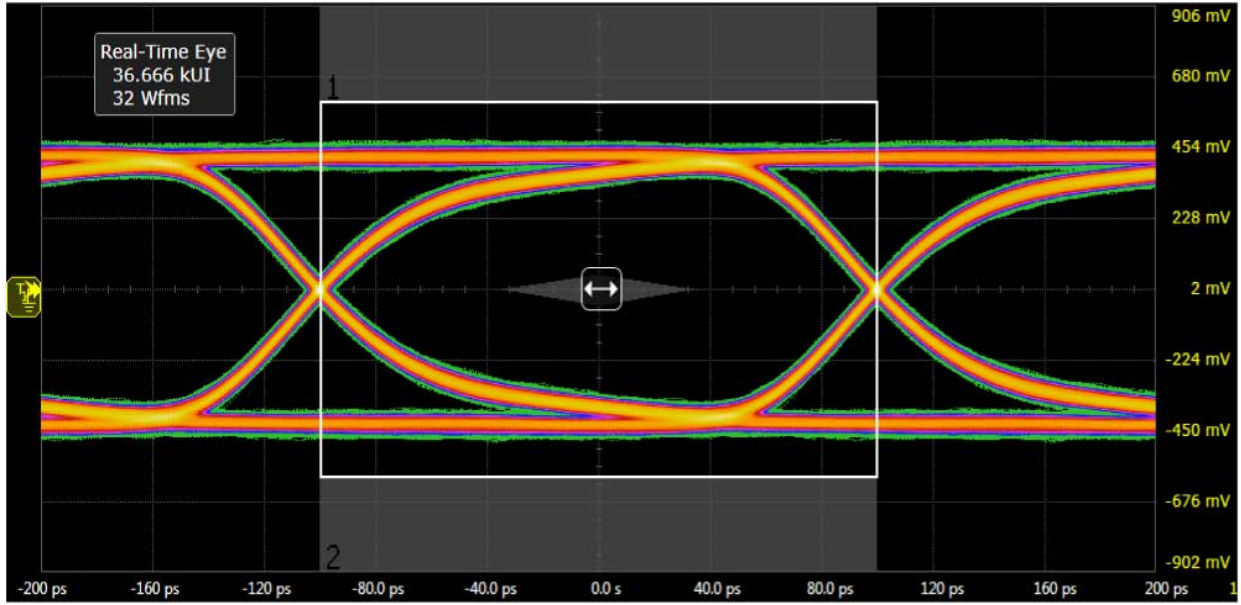
$$a = \frac{C_d}{C_d(V_{RWM} = 0 \text{ V})}$$

Fig. 4. Relative capacitance as a function of input voltage; typical values



rise time = 200 ps

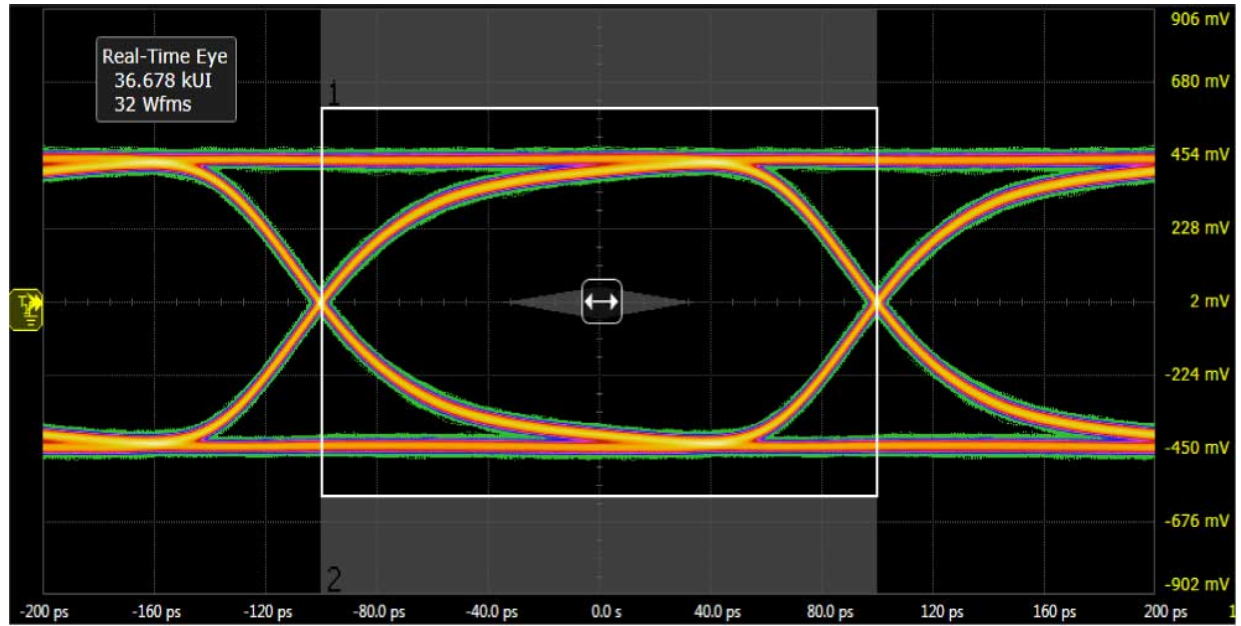
Fig. 5. Differential Time Domain Reflectometer (TDR) plot; typical values



aaa-028375

Data rate: 5 Gbit/s

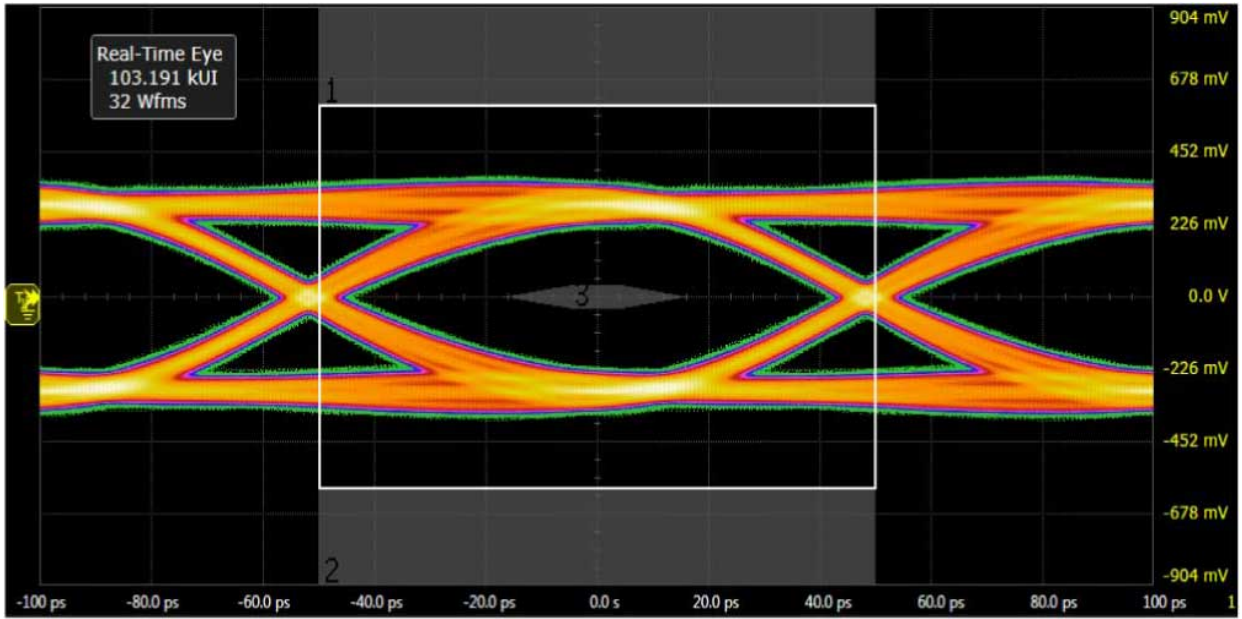
Fig. 6. USB 3.1 eye diagram, PCB with device; typical values



aaa-028376

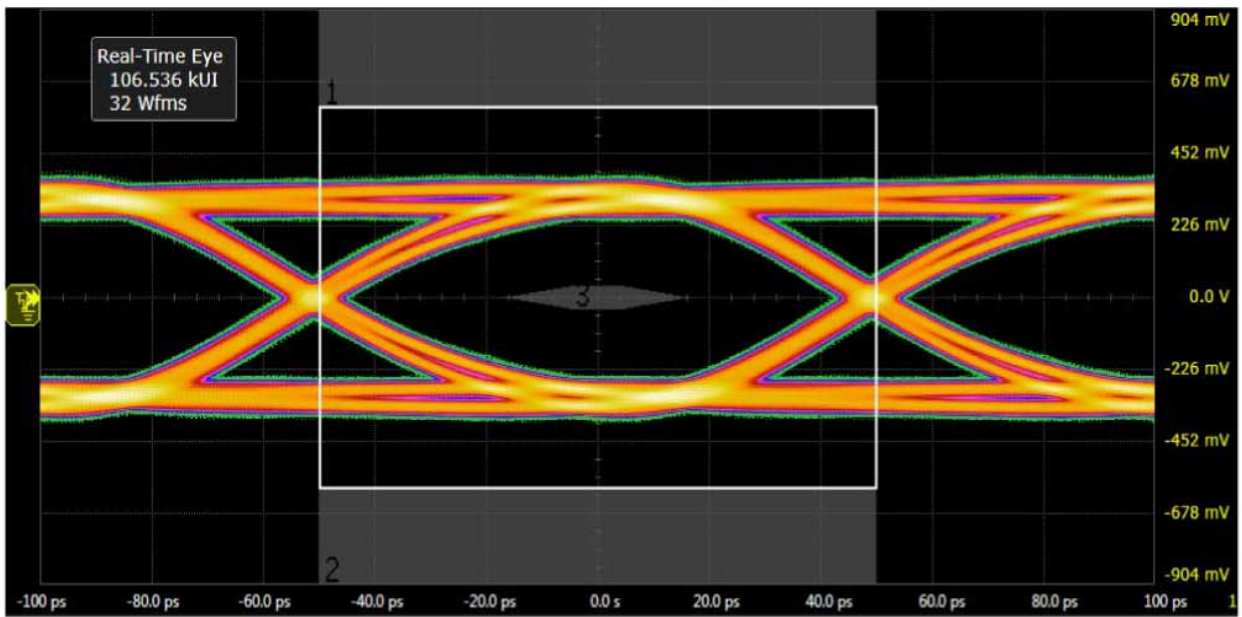
Data rate: 5 Gbit/s

Fig. 7. USB 3.1 eye diagram, PCB without device; typical values



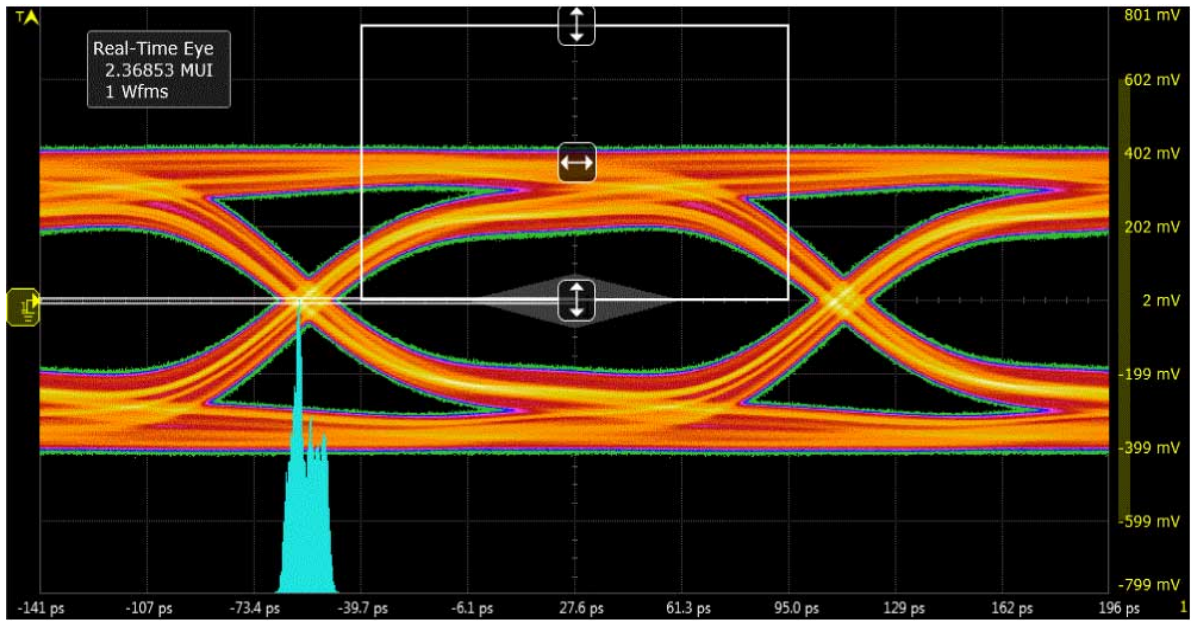
Data rate: 10 Gbit/s

Fig. 8. USB 3.1 eye diagram, PCB with device; typical values



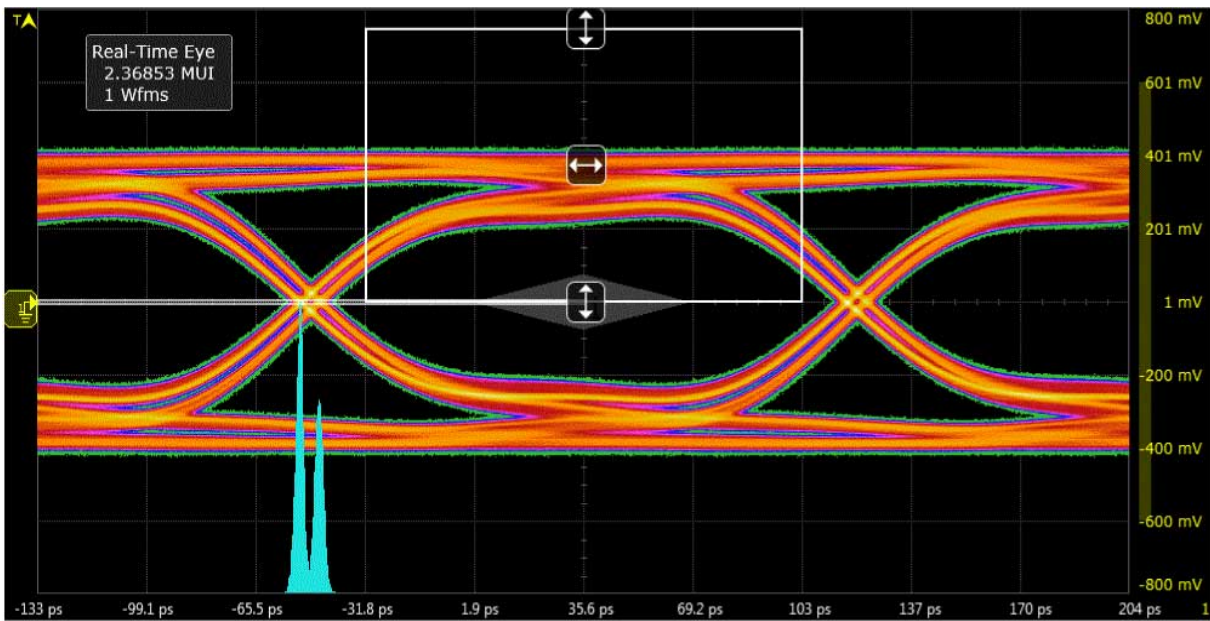
Data rate: 10 Gbit/s

Fig. 9. USB 3.1 eye diagram, PCB without device; typical values



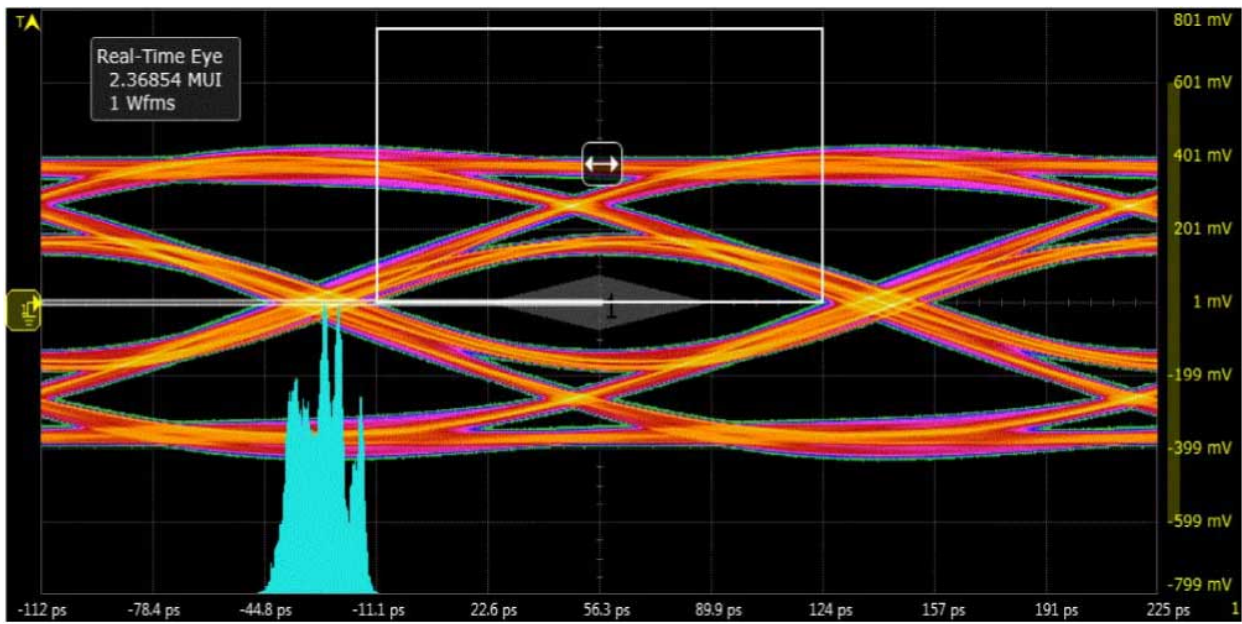
aaa-028379

Fig. 10. HDMI2.0 TP1 eye diagram, PCB with device; typical values



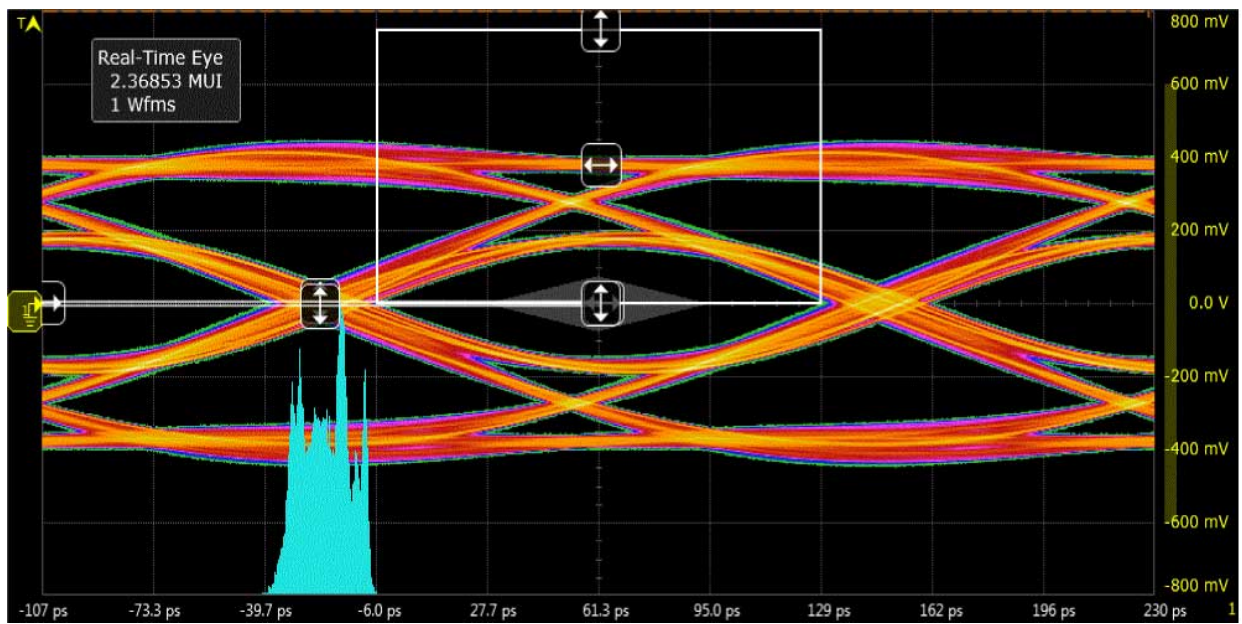
aaa-028380

Fig. 11. HDMI2.0 TP1 eye diagram, PCB without device; typical values



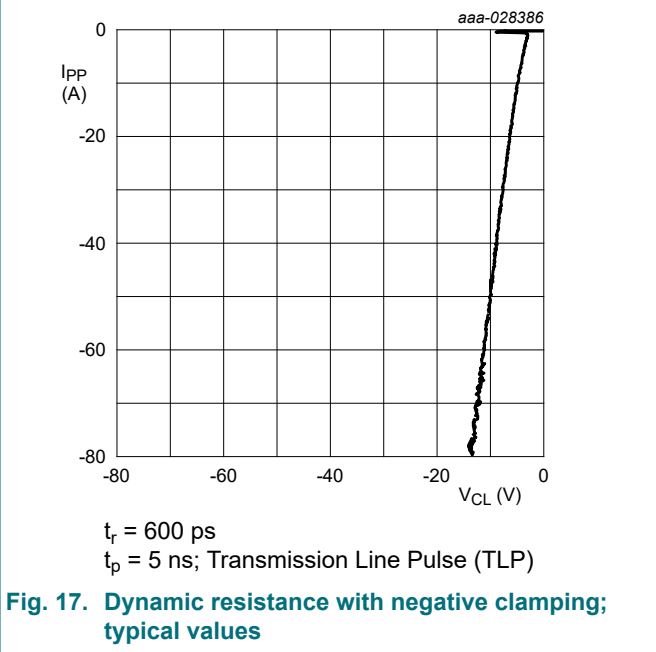
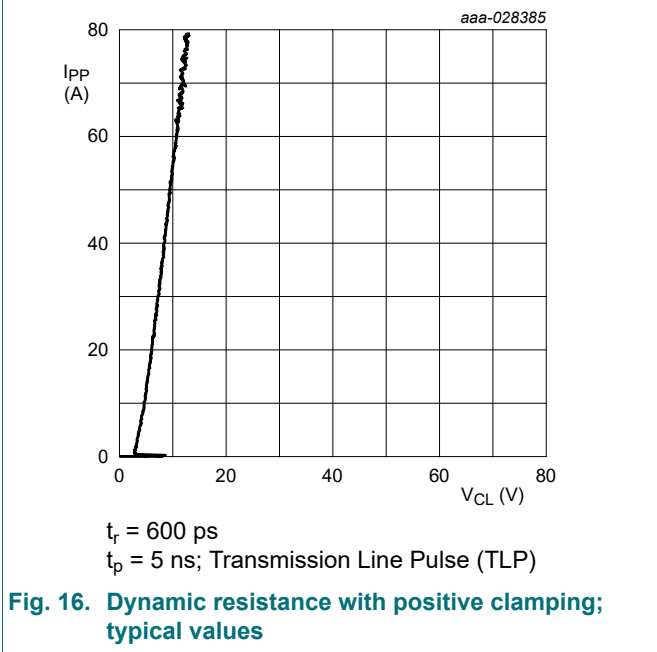
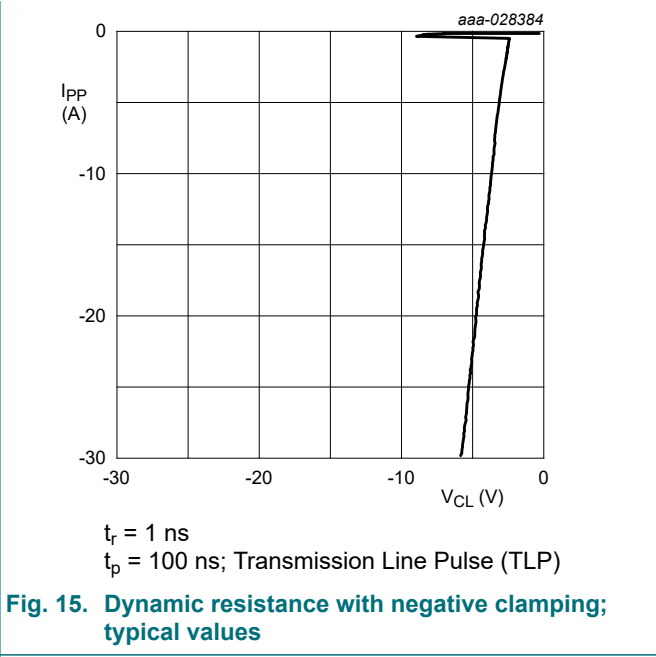
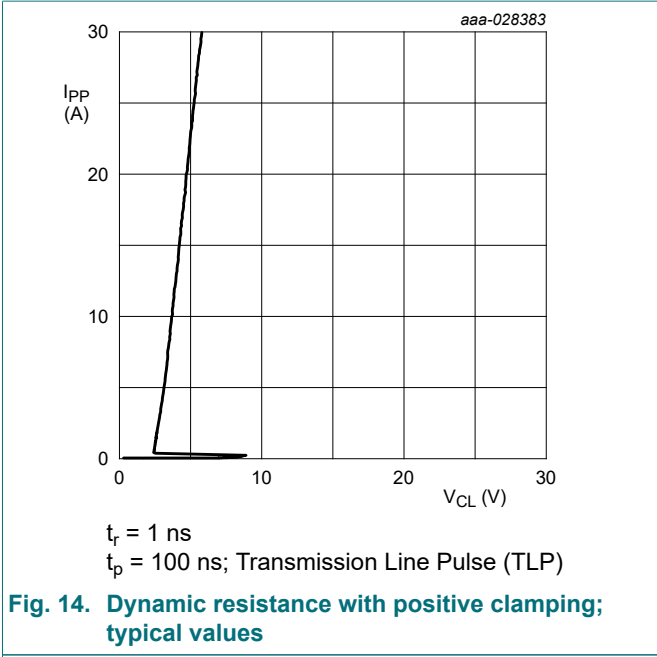
aaa-028381

Fig. 12. HDMI2.0 TP2 eye diagram, PCB with device; typical values

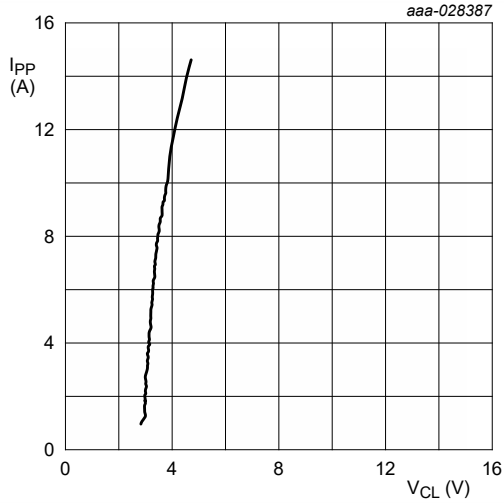


aaa-028382

Fig. 13. HDMI2.0 TP2 eye diagram, PCB without device; typical values

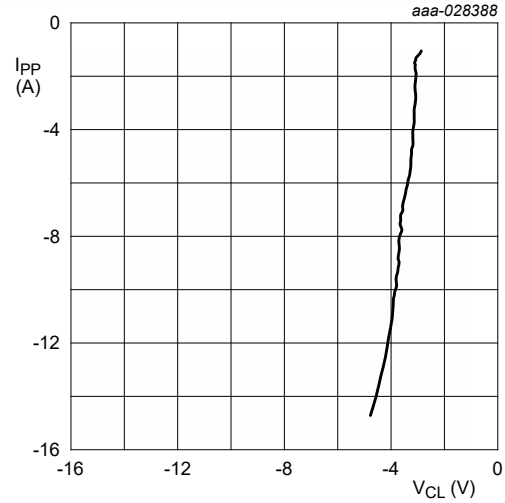


Extremely low capacitance bidirectional ESD protection diode



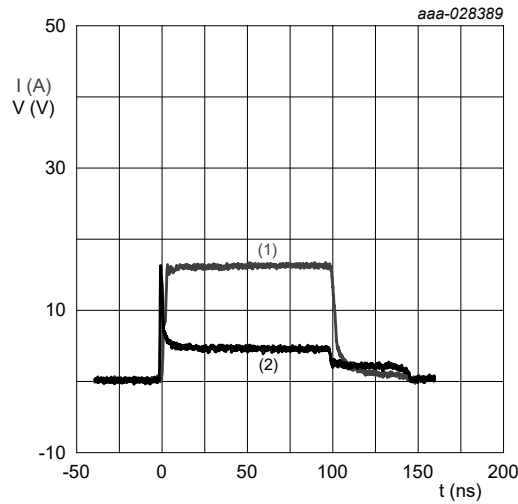
IEC 61000-4-5; $t_p = 8/20 \mu s$; positive pulse

Fig. 18. Dynamic resistance with positive clamping; typical values



IEC 61000-4-5; $t_p = 8/20 \mu s$; negative pulse

Fig. 19. Dynamic resistance with negative clamping; typical values



$t_r = 1 ns$
 (1) TLP current
 (2) TLP voltage

Fig. 20. TLP voltage and current over time, typical values

10. Application information

The device is designed for the protection of one bidirectional data line from surge pulses and ESD damage. The device is suitable on lines where the signal polarities are both positive and negative with respect to ground.

The device uses an advanced clamping structure showing a negative dynamic resistance. This snap-back behavior strongly reduces the clamping voltage to the system behind the ESD protection during an ESD event. Do not connect unlimited DC current sources to the data lines to avoid keeping the ESD protection device in snap-back state after exceeding breakdown voltage (due to an ESD pulse for instance).

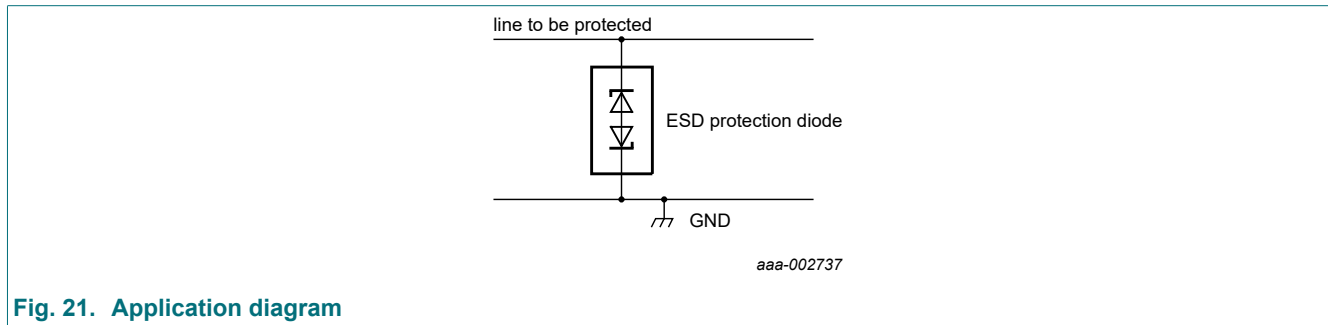


Fig. 21. Application diagram

Circuit board layout and protection device placement

Circuit board layout is critical for the suppression of ESD, Electrical Fast Transient (EFT) and surge transients. The following guidelines are recommended:

1. Place the device as close to the input terminal or connector as possible.
2. Minimize the path length between the device and the protected line.
3. Keep parallel signal paths to a minimum.
4. Avoid running protected conductors in parallel with unprotected conductors.
5. Minimize all Printed-Circuit Board (PCB) conductive loops including power and ground loops.
6. Minimize the length of the transient return path to ground.
7. Avoid using shared transient return paths to a common ground point.
8. Use ground planes whenever possible. For multilayer PCBs, use ground vias.

11. Package outline

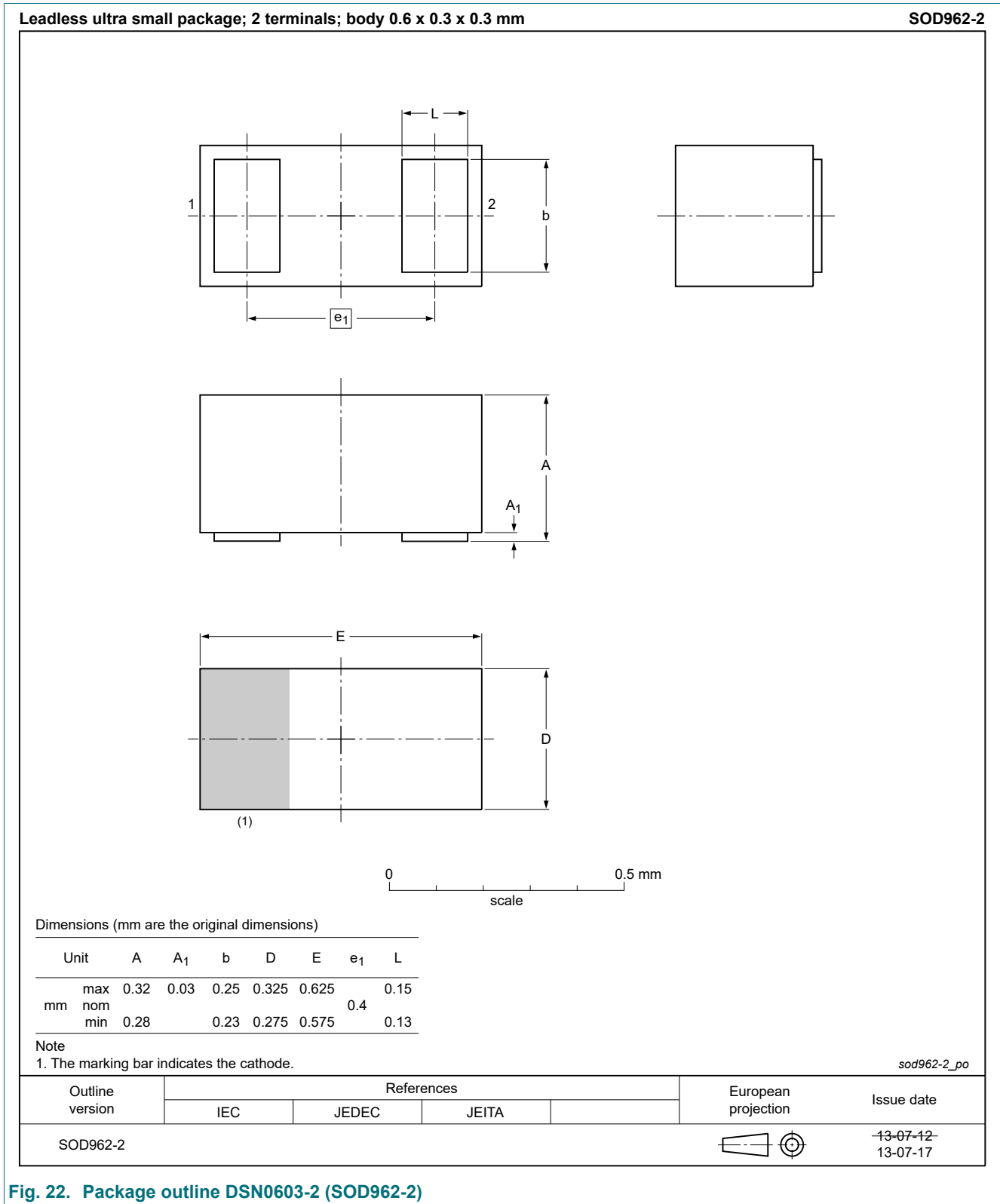
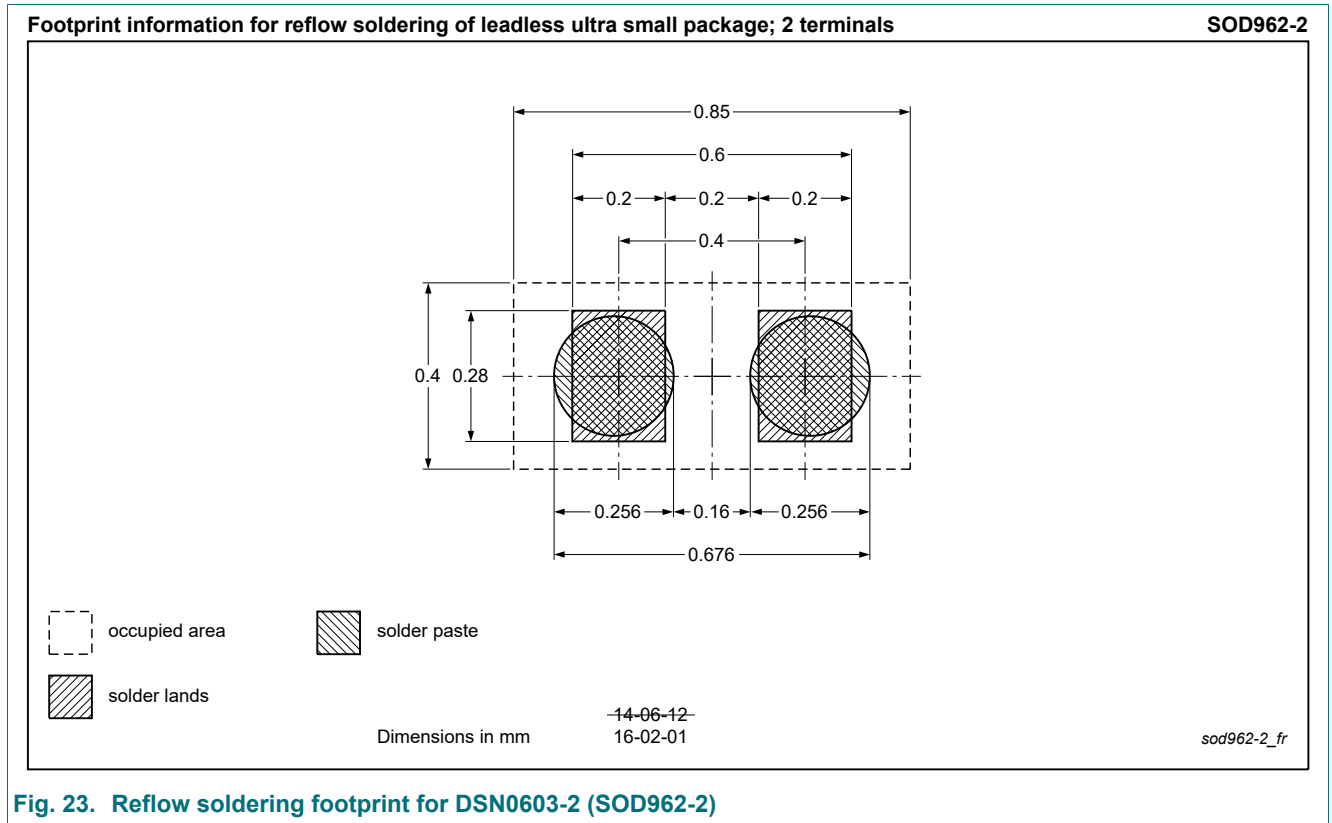


Fig. 22. Package outline DSN0603-2 (SOD962-2)

12. Soldering



13. Revision history

Table 7. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PESD4V0Z1BCSF v.2	20190329	Product data sheet	-	PESD4V0Z1BCSF v.1
Modifications:	• Updated Package			
PESD4V0Z1BCSF v.1	20180702	Product data sheet	-	-

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Nexperia product can reasonably be expected to result in personal

injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nexperia.com/profile/terms>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific Nexperia product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Nexperia accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Nexperia's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond Nexperia's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Nexperia for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Nexperia's standard warranty and Nexperia's product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

Contents

1. General description.....	1
2. Features and benefits.....	1
3. Applications.....	1
4. Quick reference data.....	1
5. Pinning information.....	2
6. Ordering information.....	2
7. Marking.....	2
8. Limiting values.....	2
9. Characteristics.....	3
10. Application information.....	11
11. Package outline.....	12
12. Soldering.....	13
13. Revision history.....	14
14. Legal information.....	15

© Nexperia B.V. 2019. All rights reserved

For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: salesaddresses@nexperia.com

Date of release: 29 March 2019
